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## Features

- DC/DC Step-up Converter (BOOST) 3.3V to 5.2V, 1A, up to 90% Efficiency. Can be Used as BUCK/BOOST in SEPIC Configuration
- DC/DC Step-down (BUCK) Synchronous Converter 0.9V to 3.4V, 500mA, up to 90% Efficiency, Pulse Skipping Capabilities for High Efficiency at Light Load Currents
- Two Low-Drop-Out Regulators 1.3V, 1.5V to 1.8V, 2.5V to 2.8V (100 mV Step), 3.3V, 200 mA Maximum Load
- Ultra-low Power Real-time Clock (RTC) and Backup Battery Management
  - 2.6V RTC LDO for Backup Battery Charging
  - 32 kHz Crystal RTC Oscillator (1  $\mu$ A)
  - RTC Circuit for Time and Date Information
- Activation of the Power Management Modules via Dedicated Enable Pin
- Automatic Start-up Sequences, POK Signal Indicating When Start-up is Completed
- Activation and Control of the Power Management Modules in Dynamic Mode (via SPI or TWI) or in Static Mode (On/Off of the Four Power Supplies)
- ITB Signal Indicating Short-circuits in DC/DC Converters
- Very Low Quiescent Current
- Minimum External Components Count
- Supply: from 2.8V to 5.25V (typ: Li-Ion Battery 3V to 4.2V)
- Available in a 32-pin 5x5 QFN Package
- Applications Include:
  - WLAN Portable Devices
  - Multimedia Devices
  - Portable Music Players

## 1. Description

The AT73C224-x is a family of ultra low cost Power Management Unit, available in a small outline QFN 5x5mm package.

The AT73C224-x family is optimized for portable applications, typically powered by a Li-Ion battery. The AT73C224-x device is also suitable to operate from a standard 3.3V to 5.25V voltage rail. It includes four power supplies and a very low power Real-time Clock (RTC). In normal mode (main battery present), the backup battery is recharged through a 2.6V RTC LDO.

The AT73C224-x series offer different automatic start-up sequences (with varying orders of power-on and specific default output values) and different soft management modes: dynamic (via SPI or TWI) with register access or static, with access to power on/off of the four power supplies.

Each AT73C224-x device is equipped with a very low power bandgap reference, low power 32 kHz and 1 MHz oscillators and an internal LDO used to generate the internal supply (VINT) equal to 2.8V. Auxiliary cells, such as a power-on reset (POR) and a voltage monitor are used to control the system power-on (battery plugged in) and power-off (battery unplugged).

The four power supplies are named: BOOST1, BUCK2, LDO3 and LDO4.

[Table 1-1](#) lists the different devices available in the AT73C224-x series.



## Power Management and Analog Companions (PMAAC)

**AT73C224-A**  
**AT73C224-B**  
**AT73C224-C**  
**AT73C224-D**  
**AT73C224-E**  
**AT73C224-F**  
**AT73C224-G**  
**AT73C224-H**

**4x Channels**  
**Power Supply:**  
**DC/DC BOOST**  
**DC/DC BUCK**  
**2x LDOs**  
**RTC**

6266A-PMAAC-08-Sep-08



For more details concerning the Automatic start-up sequences, see [Section 5.2](#).

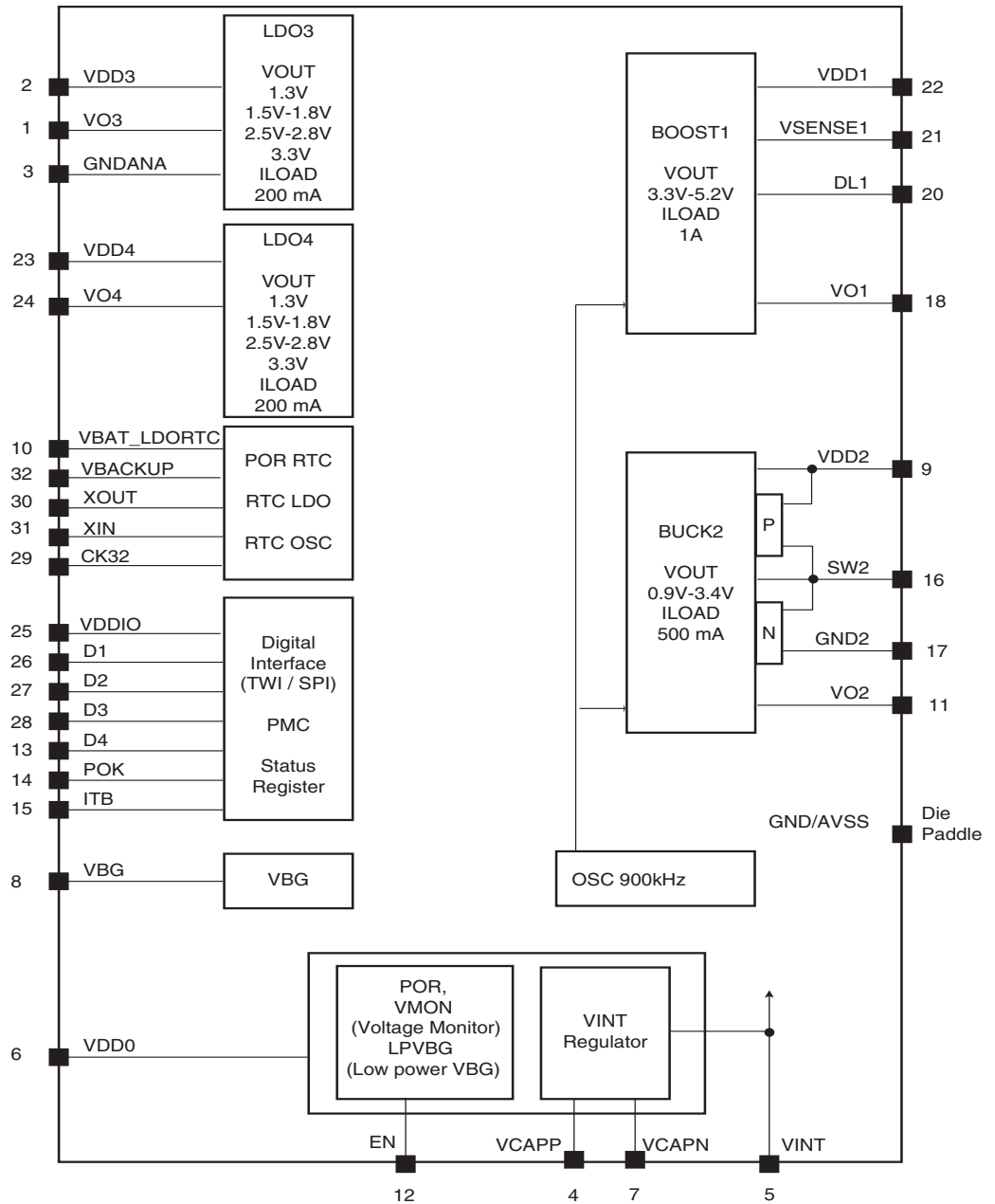
For more details concerning the Management Modes, see [Section 5.3](#).

**Table 1-1.** AT73C224-x device series

Part Number	Automatic Start-up Sequence Order of power-on and output default values.	Management Mode	Comments
AT73C224-A	1 - BUCK2= 1.8V 2 - LDO4 = 2.8V 3 - LDO3 = 2.7V	Dynamic	BOOST1 can be activated after Start-up sequence by a user command.
AT73C224-B	1 - BUCK2 = 1.2V 2 - LDO4 = 1.8V 3 - LDO3 = 1.8V	Dynamic	BOOST1 can be activated after Start-up sequence by a user command.
AT73C224-C	1 - LDO4 = 2.8V 2 - BUCK2 = 1.8V 3 - LDO3 = 2.7V	Dynamic	BOOST1 can be activated after Start-up sequence by a user command.
AT73C224-D	1 - LDO4 = 1.8V 2 - BUCK2 = 1.2V 3 - LDO3 = 1.8V	Dynamic	BOOST1 can be activated after Start-up sequence by a user command.
AT73C224-E	1 - BOOST11 = 5.2V 2 - LDO4 = 3.3V 3 - LDO3 = 3V	Dynamic	BUCK2 can be activated after Start-up sequence by a user command. LDO3 & LDO4 are supplied by BOOST1. (See <a href="#">Section 4. "Application examples"</a> , <a href="#">Figure 4-3 on page 7</a> : Application Schematic 3.)
AT73C224-F	1 - BUCK2 = 1.8V 2 - LDO4 = 2.8V 3 - LDO3 = 2.7V	Static	Same as AT73C224-A.
AT73C224-G	1 - LDO4 = 2.8V 2 - BUCK2= 1.8V 3- LDO3 = 2.7V	Static	Same as AT73C224-C.
AT73C224-H	1 - BOOST1 = 5.2V 2 - LDO4 = 3.3V 3 - LDO3 = 3V	Static	Same as AT73C224-E.

## 2. Block Diagram

Figure 2-1. Block Diagram



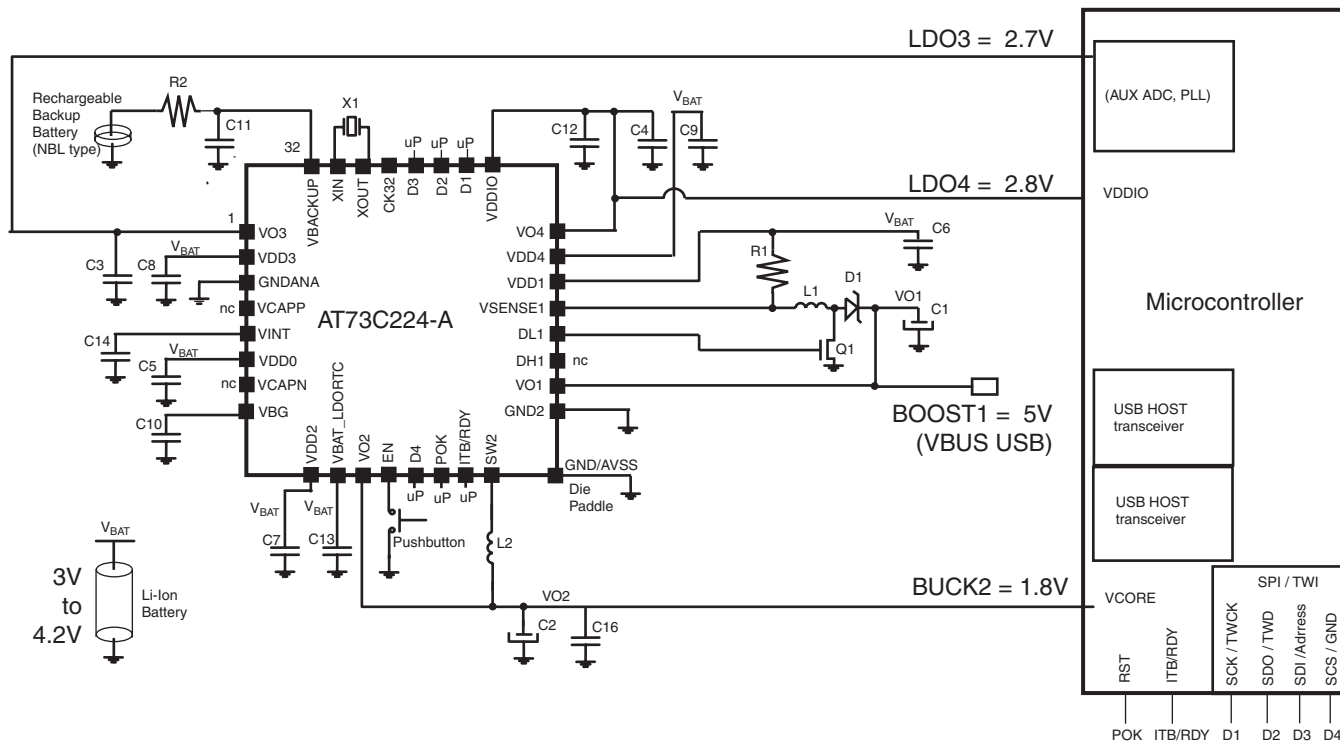
### 3. Pinout

**Table 3-1.** AT73C224 Pinout

Pin Name	I/O	Pin #	Type	Function	Comments
VO3	O	1	Analog	LDO3 output voltage	Ext. 2.2 $\mu$ F capacitor (mandatory)
VDD3	PS	2	Power	LDO3 supply voltage	
GNDANA	PS	3	Ground	Analog ground	
VCAPP	I/O	4	Analog	Not connected	
VINT	PS	5	Power	Output of the internal LDO	Ext. 470 nF capacitor (mandatory)
VDD0	PS	6	Analog	Supply of the internal LDO	Must be connected to the main battery (mandatory)
VCAPN	I/O	7	Analog	Not connected	
VBG	O	8	Analog	Bandgap reference voltage	Should not be resistively loaded
VDD2	PS	9	Power	BUCK2 supply voltage	
VBAT_LDORTC	PS	10	Power	LDO_RTC Supply voltage	Must be connected to the main battery (mandatory)
VO2	I	11	Analog	BUCK2 output voltage	
EN	I	12	Digital	Enable signal	Internal 100 K $\Omega$ pull up
D4	I	13	Digital	Digital interface	Internal 100 K $\Omega$ pull up
POK	O	14	Digital	Power Ok: indicates when start-up is completed	
ITB/RDY	I/O	15	Digital	User Interrupt, GPIO and Shutdown control	Internal 100 K $\Omega$ pull up
SW2	O	16	Analog	BUCK2 inductor (NMOS switcher output)	
GND2	PS	17	Ground	BUCK2 ground	
VO1	I	18	Analog	BOOST1 output voltage	
DH1	O	19	Analog	Not connected	
DL1	O	20	Analog	BOOST1 NMOS control signal	
VSENSE1	I	21	Analog	BOOST1 current limitation sense voltage	
VDD1	PS	22	Power	BOOST1 supply voltage	Must be connected to the main battery
VDD4	PS	23	Power	LDO4 supply voltage	
VO4	O	24	Analog	LDO4 output voltage	Ext. 2.2 $\mu$ F capacitor (mandatory)
VDDIO	PS	25	Digital supply	Supply voltage for Digital I/O	
D1	I	26	Digital	Digital interface	open drain
D2	I/O	27	Digital	Digital interface	open drain
D3	I	28	Digital	Digital interface	open drain
CK32	O	29	Digital	32 kHz RTC output clock	
XOUT	I/O	30	Analog	RTC crystal oscillator output	
XIN	I/O	31	Analog	RTC crystal oscillator input	
VBACKUP	O	32	Analog	Backup Battery and RTC supply	
GND/AVSS	PS	33	Ground	Main G <sub>ND</sub> and AV <sub>SS</sub> ground	die paddle connected to ground (mandatory)

## 4. Application examples

Figure 4-1. Application Schematic 1: Microcontroller with 5V VBUS for 2 USB Host Transceivers

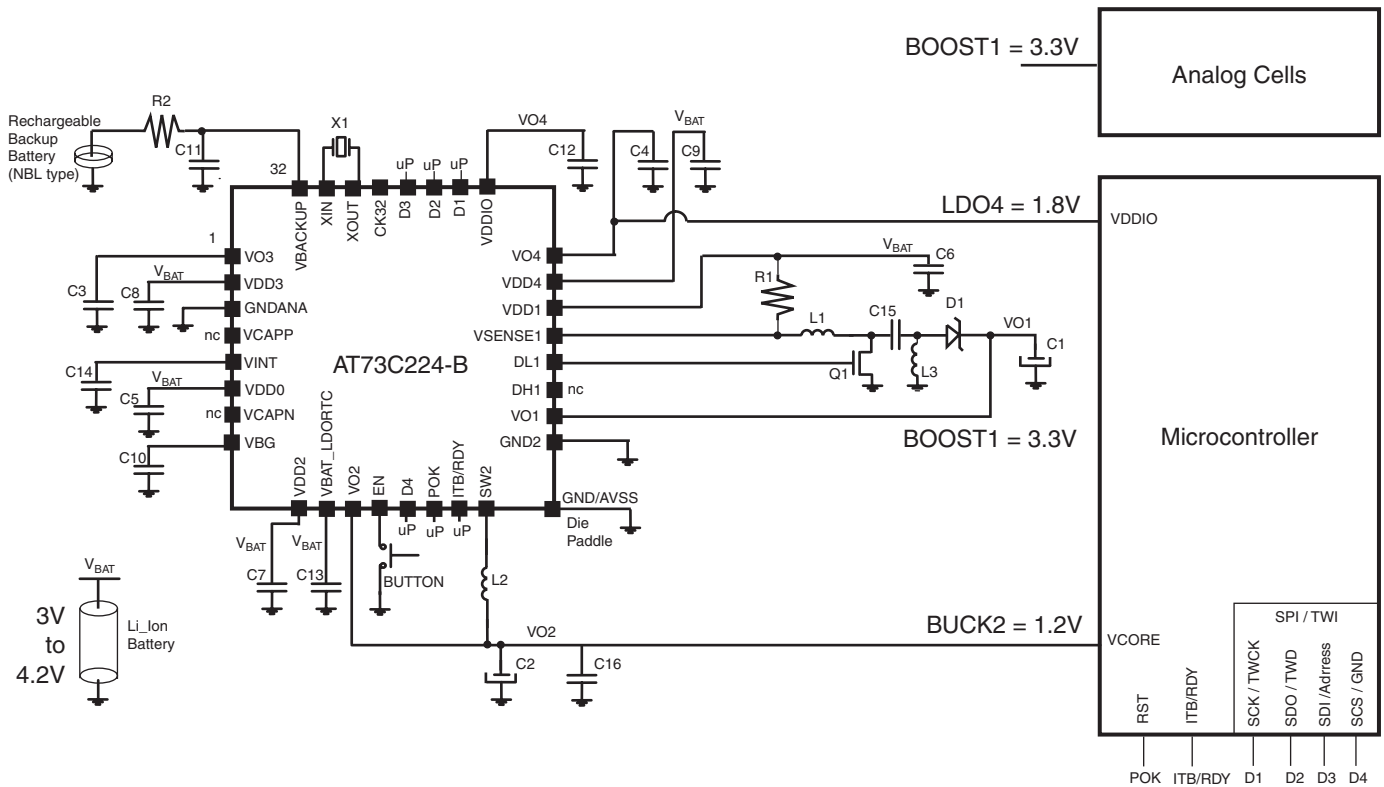


In the Application Schematic 1, the AT7373C224-A is used: the BOOST(VO1) supplies the “VBUS” of two USB transceivers, the BUCK(VO2) supplies the digital core of the microcontroller, the LDO3 supplies the I/Os of the microcontroller and LDO4 supplies analog cells, such as auxiliary ADC or PLL.

For external components, see [Table 4-1](#).



**Figure 4-3.** Application Schematic 3: BOOST in SEPIC Configuration (BUCK/BOOST)



In the Application Schematic 3, the BOOST (VO1) is in SEPIC configuration (BUCK/BOOST) and generates a 3.3V output voltage for analog cells. The BUCK (VO2) supplies the core of the microcontroller, and LDO4 supplies the I/Os.

Note that, in the SEPIC configuration, the maximum load current on VO1 should not exceed 300 mA.

For external components, see [Table 4-1](#).



**Table 4-1. External Components**

Schematic reference	Reference	Manufacturer	Value
C1	Tantalum TPS Case B	AVX®	100 $\mu$ F
C2	Tantalum TPS Case A	AVX	33 $\mu$ F
C3, C4	GRM155R60J225ME15 C1005X5R0J225MT	Murata® TDK	2.2 $\mu$ F
C6	GRM21BR60J226ME39 C2012X5R0J226MT	Murata TDK	22 $\mu$ F
C5, C7, C8, C9, C11, C13	GRM155R60J105KE19 C1005X5R0J105KT	Murata TDK	1 $\mu$ F
C10	GRM155R61A104KA01 C0603X5R0J104KT	Murata TDK	100 nF
C12, C14	GRM155R60J474KE18 C1005X5R1A474KT	Murata TDK	470 nF
C15	GRM188R60J475KE19 C1608X5R0J475KT	Murata TDK	4.7 $\mu$ F
C16	GRM188R60J106ME47 C1608X5R0J106MT	Murata TDK	10 $\mu$ F
L1	744773022	Würth® Elektronik	2.2 $\mu$ H
L1, L3 (in SEPIC config.)	744773068	Würth Elektronik	6.8 $\mu$ H
L2	B82467-G0682-M	Epcos®	6.8 $\mu$ H
D1	MBRM120LT1	On Semiconductor®	
Q1	Si1470DH	Vishay®	
X1	FX135B-327	Fox	32.768 kHz
R1 (can be printed on the board (Cu line))	LR2010R050J	Welwyn	50 m $\Omega$
R2	MR-CRG0402J2k2	Tyco™ Electronics	2 k $\Omega$

## 5. Detailed Description

The AT73C224-x is a family of Power Management Units with four power supplies and an ultra low-power Real-time Clock.

By choosing a specific ordering code “x” from A to H, different automatic start-up sequences and management modes can be selected.

The start-up sequence includes the order of power-on, as well as the default value of the power supplies (see [Section 5.2 "Automatic Start-up Sequences and Shut-down"](#)). The user can afterwards change this default value via SPI or TWI, if the dynamic mode has been chosen (see [Section 5.3 "Digital Control and Protocol"](#)).

### 5.1 Core

The core of the AT73C224-x device integrates the following blocks:

- Power-On-Reset for the backup battery.
- Internal switch and LDO dedicated to the backup battery. The output of the LDO\_RTC is set to 2.6V and the switch is on when the main battery higher than 2.8V (charge of the backup battery). See [Section 7.7](#) for electrical details.
- Real-Time-Clock digital bloc + 32 kHz oscillator.
- Power-On-Reset for the main battery.
- Voltage Monitor (VMON) of the main battery.
- Digital Power Management Control (PMC) for automatic start-up sequences. Digital output POK indicates when start-up is completed, whereas ITB digital output signal informs the user (typically the microcontroller) of a default in the DC/DCs (short-circuit) or too low main battery value.
- TWI and SPI protocol blocs.
- DC/DC Step-up converter BOOST1: A 3.3V to 5.2V(100 mV step), 1A, asynchronous DC/DC Step-up Converter available for overall system requirements. The DC/DC can be implemented through proper external components in BUCK/BOOST (SEPIC) configuration. The output voltage can be programmed via the internal registers. BOOST1 is supplied directly by the battery.
- DC/DC Step-down converter BUCK2: A 0.9V to 3.4V, 500 mA fully integrated synchronous PWM DC/DC Step-down Converter. The output voltage can be programmed via the internal registers. A Pulse Skipping mode is available in order to improve efficiency at very light load current values. In order to guarantee very low supply voltage functionality, the controller is supplied by the max voltages between the main battery and the output of BOOST1 (VO1). BUCK2 can be directly supplied by the battery or by the output of BOOST1.
- LDO3: A 1.3V, 1.5V to 1.8V (100 mV of step), 2.5V to 2.8V (100 mV of step), 3.3V, 200 mA – Low Drop out regulators. The output voltage can be programmed via the internal registers. LDO3 can work with supply from 1.8V up to 5.5V. This LDO can be supplied by the battery, by the output of BOOST1, or by the output of BUCK2.
- LDO4: same functionality than LDO3.
- Main Bandgap: 1.18V reference voltage.
- 900 kHz Oscillator.
- Internal LDO (VINT) at 2.8V for internal supply.

## 5.2 Automatic Start-up Sequences and Shut-down

### 5.2.1 Start-up/Wakeup

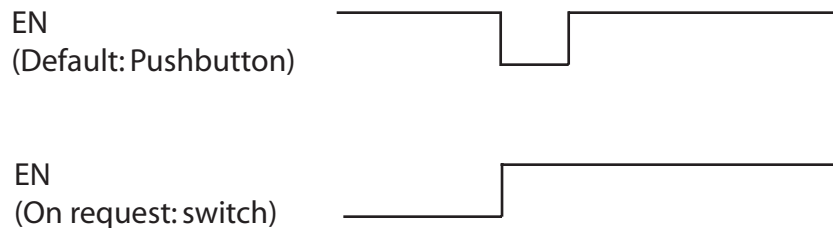
If the backup battery (only) is present, the RTC is running (1.2  $\mu$ A). This mode is called “Backup mode”. When the main battery is plugged in and voltage is higher than 2.8V, the LDO\_RTC recharges the backup battery through an internal switch (if the main battery is lower than 2.8V, nothing happens, RTC still running). This mode is called “Standby mode”. Note that when the battery is plugged in (and higher than 2.8V), a reset of the RTC is performed only if the backup battery was lower than 1.8V.

Now, the system waits for wake-up information coming from the pushbutton (EN pin) or an RTC alarm. When one of the previous conditions occurs, the automatic start-up sequence starts (without any external commands).

Different automatic start-up sequences can be chosen from the AT73C224-x family (see [Figure 5-1 on page 11](#) and [Figure 5-2 on page 12](#)).

When the automatic start-up sequence has been completed, the POK signal (which is an open drain signal) goes high, thus implementing a sort of POR for the user (i.e., a microcontroller) and enters into “Normal mode”.

Note: Power On is controlled by default by an external pushbutton, connected on EN pin (the EN pad has an internal 100 k $\Omega$  pull up). A switch can also be used as shown bellow but should be a request from the customer



### 5.2.2 Shut-down

Static and Dynamic modes are explained in detail in [Section 5.3](#).

#### 5.2.2.1 Static Mode

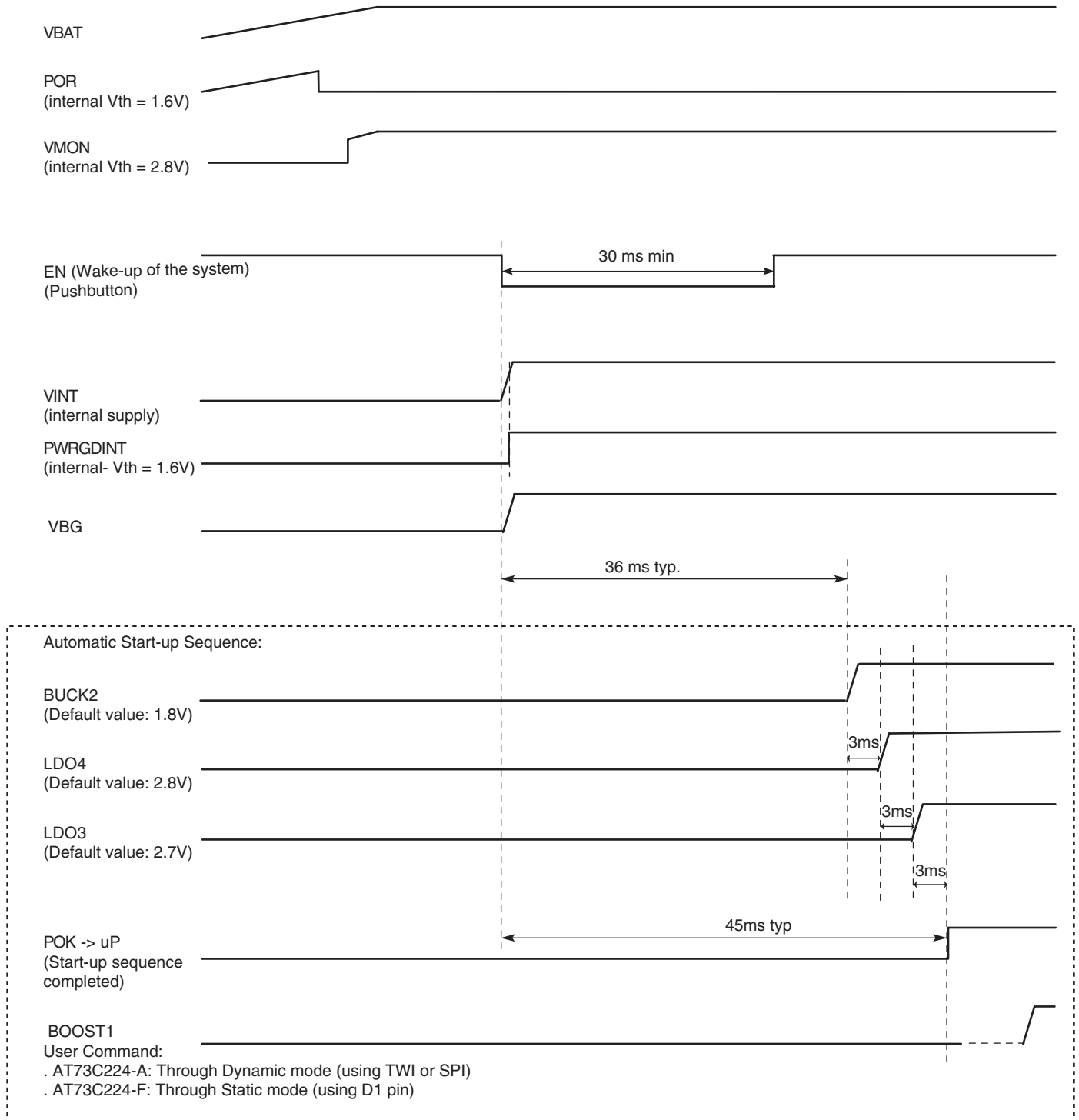
In Static mode, the Power-off condition is an OR between the following conditions: main battery lower than 2.8V or electrical default in the DC/DC (short-circuit). When Power-off condition occurs, POK signal is cleared, then the AT73C224-x device waits for the signal ITB/RDY to shut down all power supplies.

#### 5.2.2.2 Dynamic Mode

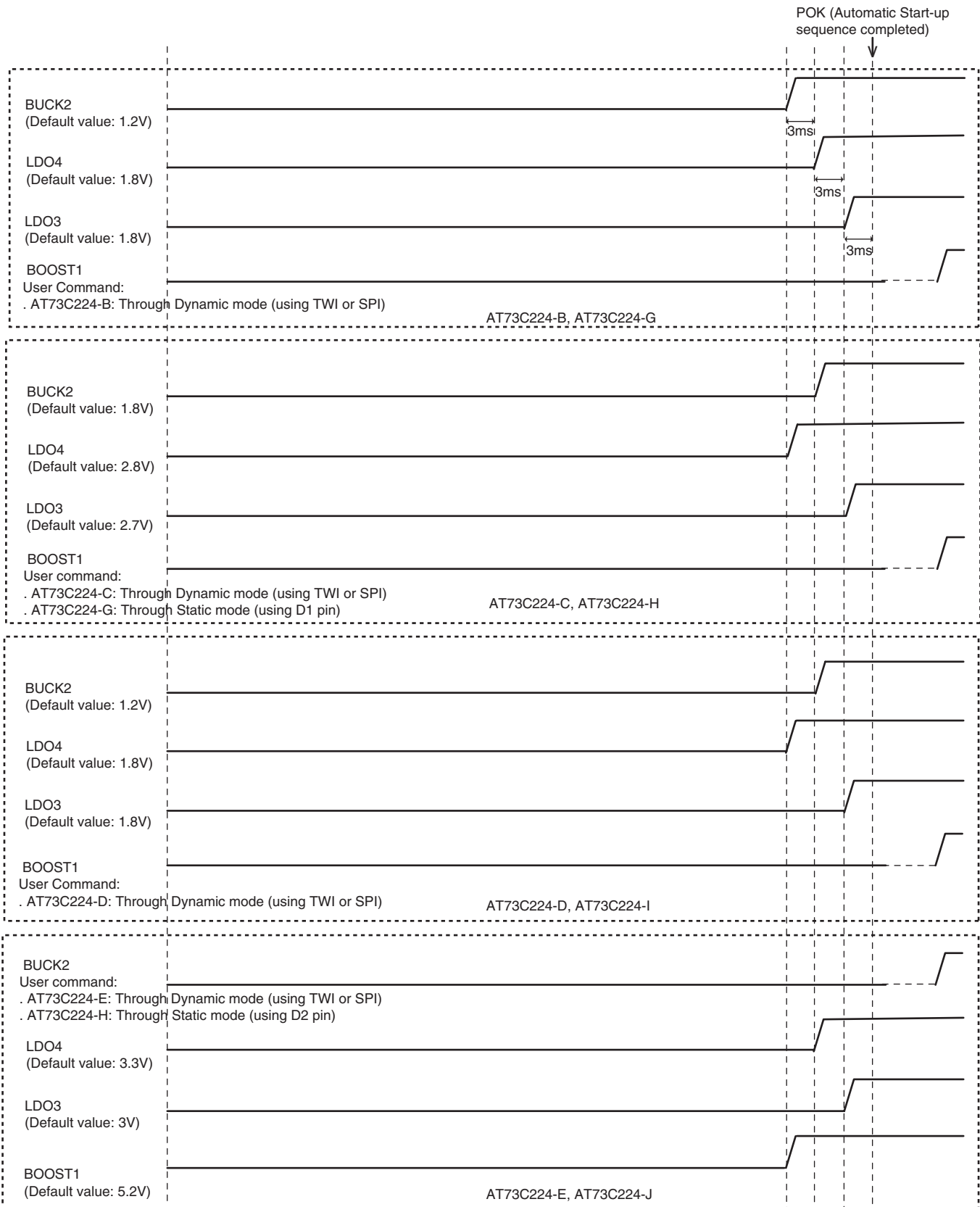
In Dynamic mode, Power-off condition is an OR between the following conditions: electrical default in the DC/DC (short-circuit) or software shutdown. When main battery lower than 2.8V, an interrupt is generated on signal ITB/RDY. It is the responsibility of the host microcontroller to perform a software shut-down by properly writing the AT73C224-x device registers through the serial interface. After that, the POK signal is cleared, and all is turned off. A check on the push-button is then performed to assure that it has been released, thus avoiding continuous on-off-on behavior. The “normal” shutdown is performed by software. Note that the microcontroller has to write the proper register to enable the power off (see [Section 6. "Register Tables"](#)).

Figure 5-1 illustrates the complete automatic start-up sequence of the AT73C224-A and AT73C224-F, whereas Figure 5-2 illustrates the automatic start-up sequence of the other AT73C224-x device versions.

**Figure 5-1.** Start up Sequence of the AT73C224-A and AT73C224-F



**Figure 5-2.** Automatic Start-up Sequence of all Other Versions of the AT73C224-x Device Series



## 5.3 Digital Control and Protocol

The AT73C224-x family offers a choice of devices in static mode or dynamic mode (see [Table 1-1 on page 2](#)). In dynamic mode, the user can manage the chip via SPI or TWI. The selection between SPI or TWI is done at start-up via the D4 pin (see [Section 5.3.2 on page 14](#)).

### 5.3.1 Static Mode

When the AT73C224-x is established in Static Mode, the digital interface signals, D1 to D4, directly drive the enable of the four supplies. During start-up, these enable signals are driven by the internal state machine. To ensure a safe transition between the start-up state and the established state, a handshake protocol must be respected. This transition period is especially important in a microcontroller environment, as the microcontroller controlling the D1-D4 signals may require an unknown period of time to actually drive these pins.

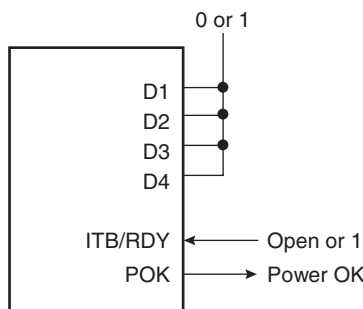
In Static Mode, the ITB/RDY pin is configured as an input with controllable pull-up resistor. When the internal state machine completes the supply start-up, it latches the value of ITB/RDY and then sets the POK signal to 1. This means that start-up is accomplished. The state machine then checks for changes on ITB/RDY. If no changes are detected, the control of the four supply channels remains with the state machine. If a change is detected the internal pullup is disconnected and the control is passed on to D1-D4, with the assignment shown in [Table 5-2](#) below.

**Table 5-1.** D1-D4 Signal Assignment

Digital Interface Signal	Supply Enable
D1	Enables BOOST1
D2	Enables BUCK2
D3	Enables LDO3
D4	Enables LDO4

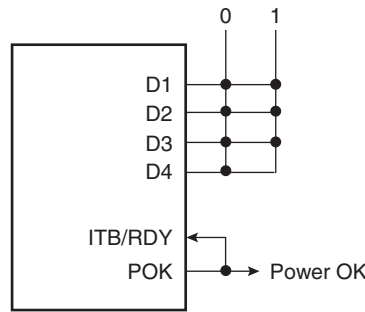
The illustrations in [Figure 5-3](#), [Figure 5-5](#) and [Figure 5-5](#) represent possible static mode scenarios.

**Figure 5-3.** Fully Static Mode



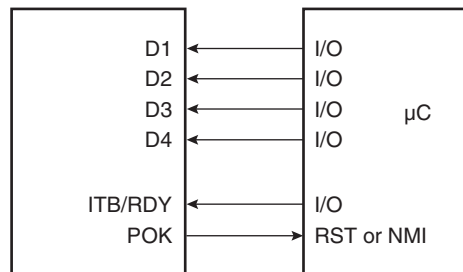
Since ITB/RDY is 1 or open (weak internal pullup), the state of each supply channel is determined by the internal state machine (Automatic Start-up sequence and default values for the three power supplies). In this configuration, the 4th power supply is off and can not be used. D1-D4 is not considered, but must be valid. The POK signal can be used as a global system reset.

**Figure 5-4.** Configurable Static Mode



The state of each channel is determined by the internal state machine during the start-up sequence. POK is looped back onto ITB/RDY. When this signal changes from 0 to 1 (i.e., the start-up is completed), the control of each supply channel is passed on to D1-D4. This allows changing the output values defined by the state machine. This mode can be used when the 4th channel is needed.

**Figure 5-5.** GPIO ( $\mu$ C Controlled)



When the system is powered, the microcontroller is not necessarily well configured and may be unable to drive D1-D4 correctly. Since ITB/RDY is not actively controlled, its state is an unknown logic level. If ITB/RDY is in hi-Z, the weak internal pullup pulls the level to 1. The power channels are controlled by the internal state machine. After some initialization time, the microcontroller configures its GPIOs to drive D1-D4 as wished. At the end of the software configuration, the microcontroller changes the level of ITB/RDY to 0 in order to get control on the four power channels through D1-D4.

### 5.3.2 Dynamic Mode

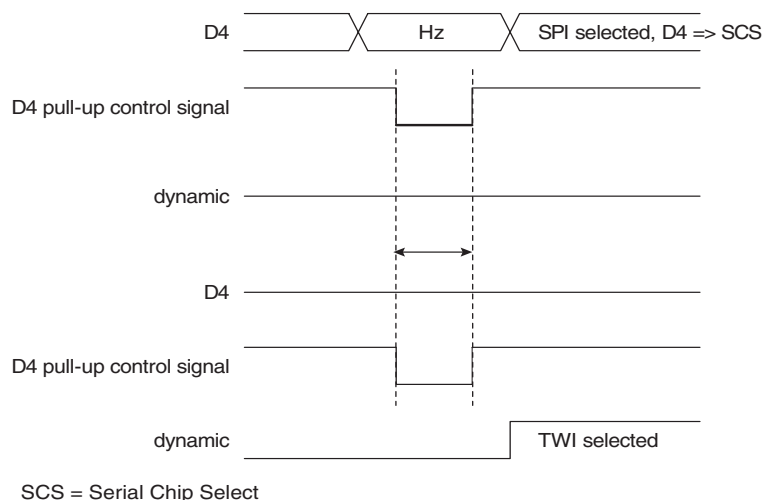
For the devices of the AT73C224-x family that work in dynamic mode, supply management can be performed by the SPI or TWI digital interface. Selection between the two digital interfaces is done through D4 pin when the AT73C224-x is enabled. Pin D4 is a digital input pin that features a controllable pull-up resistor with active low control signal. When the AT73C224-x starts, the pullup is disabled until a push button event is detected. The state machine enables the pull-up resistor on D4, waits for a time and then checks back on the value on the pad.

- If D4 is high (i.e., the level externally applied on D4 is HZ or logic 1), SPI interface is selected. D4 will become SCS.
- If D4 is low (i.e., D4 is externally grounded), TWI interface is selected. D4 is not used.

After signal dynamic has been determined the state machine disables the pull-up resistor to save power and the D4 pin can be normally used (if SPI has been selected).

The selection between SPI versus TWI is performed once, each time the start-up sequence is executed. A timing diagram of the interface selection is shown in Figure 5-6. Care must be taken to leave enough time between the activation of the pullup and the moment when D4 is sampled back. This time is necessary to load the capacitance of the net layout where D4 is connected through the pull-up resistor (100 kΩ typ.). This time is in the order of magnitude of 1 μs (10 pF \* 100 kΩ), i.e. only a few cycles of the 900 kHz oscillator are needed.

**Figure 5-6.** Dynamic Mode Interface Selection



**Table 5-2.** Digital Interface Selection

Digital Signal Interface	Pad	SPI Selection		TWI Selection	
		Signal	Direction	Signal	Direction
D1	I	SCK	In	TWCK	In
D2	BIDIR	SDO	Out	TWD	I/O
D3	I	SDI	In	Select the 7-bit fixed address	In
D4 <sup>(1)</sup>	I	SCS	In	grounded	-

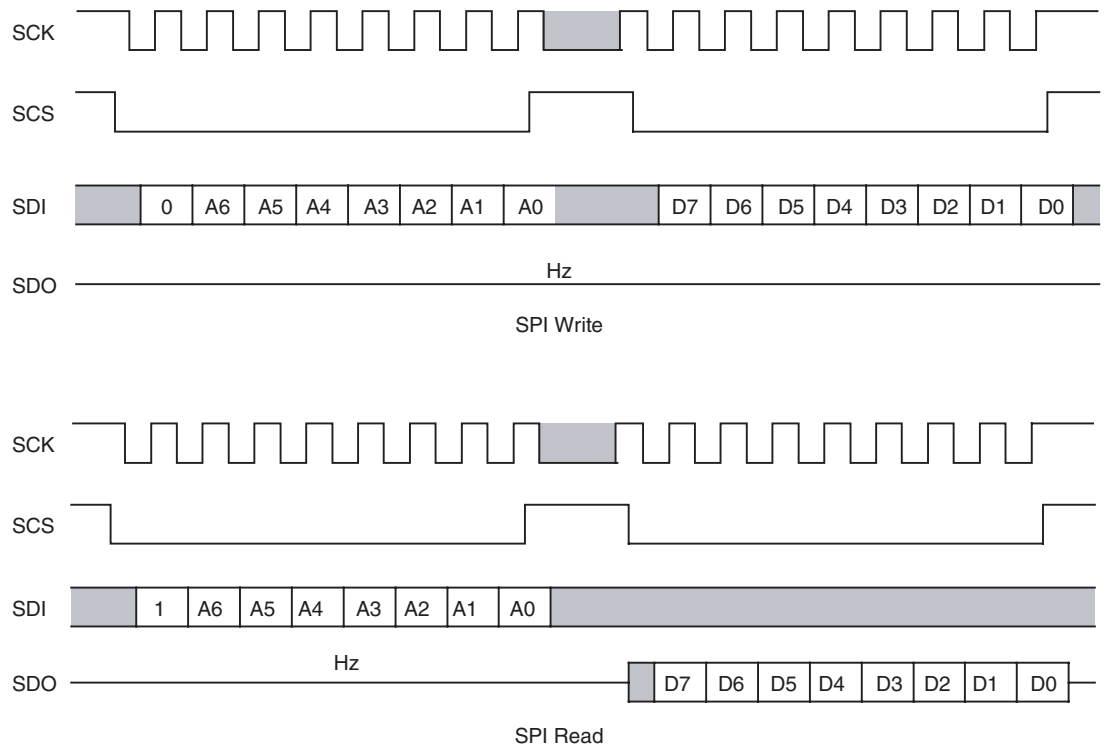
Note: 1. On D4, I = Input pad with controllable pull-up resistor.

### 5.3.2.1 SPI Operation

When SPI mode is selected, the control interface to the AT73C224-x chip is a 4-wire interface modeled after commonly available microcontroller and serial-peripheral devices. The interface consists of a serial clock (SCK), chip select (SCS), serial data input (SDI) and serial data output (SDO). Data is transferred one byte at a time with each register access consisting of a pair of byte transfers. [Figure 5-7](#) below illustrates read and write operations in SPI mode.



**Figure 5-7. SPI Read and Write Operations**



The first byte of a pair is the command/address byte. The most significant bit of this byte indicates register read when 1 and register write when 0. The remaining seven bits of the command/address byte indicate the address of the register to be accessed.

The second byte of the pair is the data byte. During a read operation, the SDO becomes active and the 8-bit contents of the register are driven out MSB first. The SDO will be in high impedance on either the falling edge of SCK following the LSB or the rising edge of SCS, whichever occurs first.

SDI is a don't care during the data portion of read operations. During write operations, data is driven into the AT73C224-x via the SDI pin, MSB first. The SDO pin will remain in high impedance during write operations. Data always transitions with the falling edge of the clock and is latched on the rising edge. The clock should return to a logic high when no transfer is in progress.

- **Continuous clocking:** In normal operation, the SCK should not transition out of byte transfer periods. However, in test mode, the SCK is used as the main clock. This implies that all data transfers must be controlled by the assertion of the SCS pin.
- **3-wire operation:** SDI and SDO can be treated as two separate lines or wired together if the master is capable of tri-stating its output during the data-byte transfer of a read operation.
- **SCK vs internal clock rates:** It is very likely that the bit rate commanded by SCK will be much higher than the internal clock (900 kHz/64) used to read and write the registers. This implies that a minimal delay between byte transfers must be imposed to allow some time to decode the address and actually access the physical register. It is **not acceptable** to sample SCK with the internal clock.

## 5.3.2.2 TWI Operation

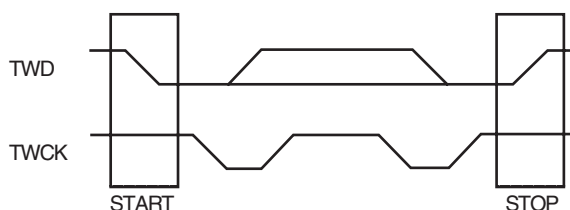
The TWI interface allows a microcontroller to proceed to read or write accesses to the internal registers of the AT73C224-x. Unlike the SPI, the TWI operation is based on a standard which defines a data-link layer and an addressing scheme. The TWI implementation used in the AT73C224-x conforms to this standard, with the following restrictions:

- slave only
- bit rate: 400 kbps max
- 7-bit fixed address: the default value is **1001001** (D3 is high). But the external D3 bit can modify it. When D3 is low, the 7-bit fixed address is **1001000**.
- TWCK is an input pin for the clock
- TWD is a bidirectional pin driving (open drain with external resistor connected to  $V_{DDIO}$ ) or receiving the serial data.

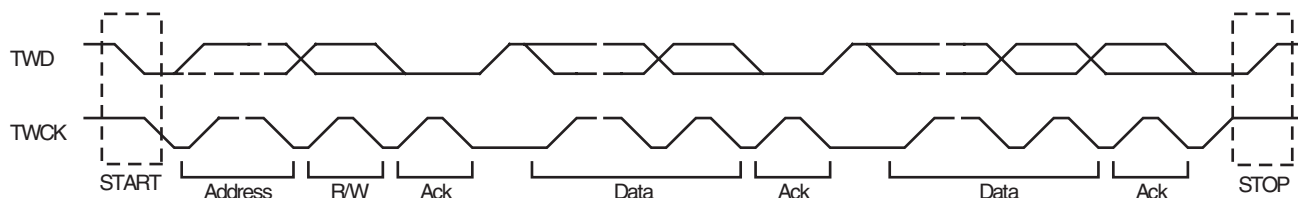
The data put on TWD line must be 8 bits long. Data is transferred MSB first. Each byte must be followed by an acknowledgement. Each transfer begins with a Start condition and terminates with a STOP condition.

- A high-to-low transition on TWD while TWCK is high defines a START condition.
- A low-to-high transition on TWD while TWCK is high defines a STOP condition.

**Figure 5-8.** TWI Start/Stop Condition



**Figure 5-9.** TWI Protocol



After the host initiates a START condition, it sends the 7-bit slave address, as defined above, to notify the slave device. A Read/Write bit follows (Read = 1, Write = 0). The device acknowledges each received byte. The first byte sent after device address and R/W bit is the address of the device register the host wants to read or write. For a write operation, the data follows the internal address. For a read operation, a repeated START condition needs to be generated followed by a read on the device.

Write and Read operations are shown in [Figure 5-8](#) and [Figure 5-9](#).

The TWI abbreviations are defined below.

S = Start	A = Acknowledge
P = Stop	N = Not Acknowledge
W = Write	ADDR = Device Address
R = Read	IADDR = Internal Address

**Figure 5-10.** Write Operation



**Figure 5-11.** Read Operation



### 5.3.3 Interrupt Controller

In dynamic mode, the ITB/RDY pin is an output and operates as an interrupt to an external microcontroller. The output logic is active low (a 0 level means interrupt).

Several sources can potentially trigger an interrupt:

- the RTC, when a real-time alarm event occurs (see [Section 7.8 "Real-time Clock \(RTC\)"](#) for more details)
- the push-button, when its state changes
- the power monitor, when it detects a failure or main battery lower than 2.7V
- the boost, when it detects a failure
- the buck, when it detects a failure

Each of these sources can be individually masked to disable the corresponding interrupt. All the interrupt logic can also be globally disabled when the microcontroller needs to enter an uninteruptible state. The interrupt enable/disable logic is controlled through two independent registers. Refer to [Section 6. "Register Tables"](#) for detailed register and bit assignment. IRQ\_EN is used to enable the interrupts, while IRQ\_DIS is used to disable the interrupts. This strategy allows the controlling software to handle the interrupt mask completely independently for each interrupt source while avoiding read-modify-write operations. The register IRQ\_MSK can be read to know the current interrupt mask.

The sequence shown below in [Table 5-3](#) shows an example of interrupt masking/unmasking.

**Table 5-3.** Interrupt Masking/Unmasking

Action	What it Does	Contents of IRQ_MSK
Reset	Disables all interrupts individually and globally.	00000000
Write 00000101 in IRQ_EN	Enables the RTC interrupt and the power failure interrupt individually. The interrupts are still globally masked, no interrupt can be triggered yet.	00000101
Write 00000000 in IRQ_EN	Nothing happens, only bits set at one have an effect.	00000101
Write 10000000 in IRQ_EN	Enables the interrupts globally. The ITB pin will toggle to 0 if either the RTC or the power monitor requests an interrupt.	10000101
Write 00000001 in IRQ_DIS	Disables the RTC interrupt. The power failure interrupt remains active.	10000100

Once the interrupt request is active on the ITB/RDY pin, the microcontroller has to handle it. To determine the reason for being interrupted, it reads the interrupt status register IRQ\_STA (this action resets ITB/RDY). In this register, each potential interrupt source has a bit which indicates if it is responsible for triggering the request.

Once the source is identified, the microcontroller performs the handling routine in an application-dependant manner. It then needs to acknowledge the interrupt source to avoid being interrupted again for the same reason.

## 6. Register Tables

Default values appear beneath the bit fields in the register description tables that follow.

### 6.1 System Registers

#### 6.1.1 7-bit Fixed Address for TWI

Register Name: TWIADDR  
 Access Type: Read-only  
 Address: 0x01

7	6	5	4	3	2	1	0
ALT	ADDR						
1	1	0	0	1	0	0	1

- **ADDR:**

Reads the TWI address currently in use. This field can be used to check the connectivity of the TWI, or to identify the AT73C224-x device. When ALT bit is 0, ADDR contains the alternate address (0x48). When ALT is 1, ADDR contains the default address (0x49).

- **ALT:**

Indicates if the TWI address is the default or the alternate.

0: the default address is selected.

1: the alternate address is selected.

The reset value depends on the configuration of the fuses. When the fuses are blank, the reset value is 0 (manufacturing default).

#### 6.1.2 Button Status Register

Register Name: BT\_SR  
 Access Type: Read-only  
 Address: 0x02

7	6	5	4	3	2	1	0
-	-	-	-	-	-	HIGH	LOW
						0	0

- **Low:**

0: the button input has not been seen low.

1: the button input has been seen low.

- **High:**

0: the button input has not been seen high.

1: the button input has been seen high.

### 6.1.3 Button Status Clear Command Register

Register Name: BT\_SCCR  
 Access Type: Write-only  
 Address: 0x03

7	6	5	4	3	2	1	0
-	-	-	-	-	-	HIGH	LOW
						0	0

A minimum of 3 clock cycles of 15 kHz clock must be waited after any write operation before doing a new register access.

• **Low:**

0: no effect.

1: clears LOW in BT\_SR.

• **High:**

0: no effect.

1: clears HIGH in BT\_SR.

### 6.1.4 Button Interrupt Enable Register

Register Name: BT\_IER  
 Access Type: Write-only  
 Address: 0x04

7	6	5	4	3	2	1	0
-	-	-	-	-	-	HIGH	LOW
						0	0

A minimum of 3 clock cycles of 15 kHz clock must be waited after any write operation before doing a new register access.

• **Low:**

0: no effect.

1: the button low interrupt is enabled.

• **High:**

0: no effect.

1: the button high interrupt is enabled.

### 6.1.5 Button Interrupt Disable Register

Register Name: BT\_IDR  
 Access Type: Write-only  
 Address: 0x05

7	6	5	4	3	2	1	0
–	–	–	–	–	–	HIGH	LOW
						0	0

A minimum of 3 clock cycles of 15 kHz clock must be waited after any write operation before doing a new register access.

• **Low:**

0: no effect.

1: the button low interrupt is disabled.

• **High:**

0: no effect.

1: the button high interrupt is disabled.

### 6.1.6 Button Interrupt Mask Register

Register Name: BT\_IMR  
 Access Type: Read-only  
 Address: 0x06

7	6	5	4	3	2	1	0
–	–	–	–	–	–	HIGH	LOW
						0	0

• **Low:**

0: the button low interrupt is disabled.

1: the button low interrupt is enabled.

• **High:**

0: the button low interrupt is disabled.

1: the button low interrupt is enabled.

### 6.1.7 Software Shutdown Command Register

Register Name: SHUTDN  
 Access Type: Write-only  
 Address: 0x07

7	6	5	4	3	2	1	0
–	–	–	–	–	–	–	LOW
							0

A minimum of 3 clock cycles of 15 kHz clock must be waited after any write operation before doing a new register access.

0: no effect.

1: shutdown the whole chip.

## 6.2 PMU Registers

### 6.2.1 BOOST Command Register

Register Name: BST\_CLR  
 Access Type: Read/Write  
 Address: 0x10

7	6	5	4	3	2	1	0
-	-	-	-	-	-	-	EN(*)

A minimum of 3 clock cycles of 15 kHz clock must be waited after any write operation before doing a new register access.

- **EN:**

Writing EN to 1 starts the BOOST/SEPIC converter.

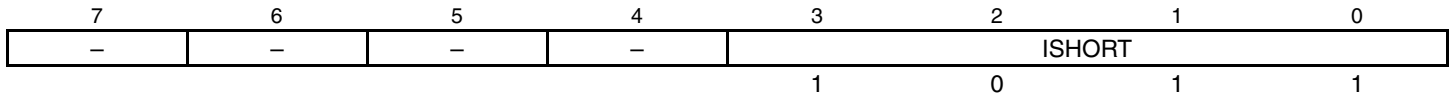
Writing En to 0 stops the BOOST/SEPIC converter.

(\*): Default value depends on the chosen AT73C224-x device (see [Section 5.2](#)).



### 6.2.2 BOOST Configuration Register

Register Name: BST\_CFG  
 Access Type: Read/Write  
 Address: 0x11



- **ISHORT:**

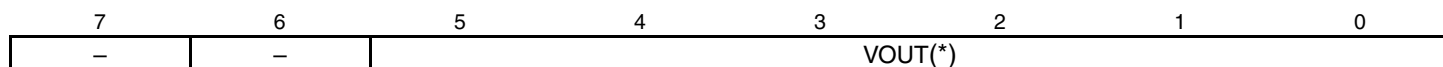
Selects the overcurrent threshold. When the external sense resistor is 50 mOhms, the lookup table below applies.

ISHORT	Threshold (Amps)
0000b	0.5
0001b	1.0
0010b	1.5
0011b	2.0
0100b	2.5
0101b	3.0
0110b	3.5
0111b	4.0
1000b	4.5
1001b	5.0
1010b	5.5
1011b	6.0
1100b	6.5
1101b	7.0

At the startup, it is recommended to put 1 Amp over current threshold in order not to generate a reset of the product.

## 6.2.3 BOOST Voltage Register

Register Name: BST\_VOLT  
 Access Type: Read/Write  
 Address: 0x12



• **VOUT:**

Selects the output voltage of the regulator following the table below. VOUT should always be higher than VDD1 in BOOST configuration (Application schematic 1). It can be programmed lower in SEPIC configuration (Application Schematic 2).

V <sub>OUT</sub> [5:0]	V <sub>OUT</sub> [V]	V <sub>OUT</sub> [5:0]	V <sub>OUT</sub> [V]
000000	not permitted	010101	3.3
000001	not permitted	010110	3.4
000010	not permitted	010111	3.5
000011	not permitted	011000	3.6
000100	not permitted	011001	3.7
000101	not permitted	011010	3.8
000110	not permitted	011011	3.9
000111	not permitted	011100	4.0
001000	not permitted	011101	4.1
001001	not permitted	011110	4.2
001010	not permitted	011111	4.3
001011	not permitted	100000	4.4
001100	not permitted	100001	4.5
001101	not permitted	100010	4.6
001110	not permitted	100011	4.7
001111	not permitted	100100	4.8
010000	not permitted	100101	4.9
010001	not permitted	100110	5.0
010010	not permitted	100111	5.1
010011	not permitted	101000	5.2
010100	3.2	—	

(\*): Default value depends on the chosen AT73C224-x device (see [Section 5.2](#)). The chosen value should always be higher than the supply of the cell (VDD1).